

## FEATURES

- RS-485 transceiver with electrical data isolation
- Complies with ANSI TIA/EIA RS-485-A and ISO 8482: 1987(E)
- 500 kbps data rate
- Slew rate-limited driver outputs
- Low power operation: 2.5 mA max
- Suitable for 5 V or 3 V operations ( $V_{DD1}$ )
- High common-mode transient immunity: >25 kV/ $\mu$ s
- True fail-safe receiver inputs
- Chatter-free power-up/power-down protection
- 256 nodes on bus
- Thermal shutdown protection
- Safety and regulatory approvals
  - UL recognition: 2500 V rms for 1 minute per UL 1577
  - CSA Component Acceptance Notice 5A
  - IEC 609501 800 V rms (basic), 400 V rms (reinforced)
  - VDE Certificate of Conformity
  - DIN V VDE V 0884-10 (VDE V 0884-10): 2006-12
  - $V_{IORM} = 560$  V peak
  - CQC certification per GB4943.1-2011
- Operating temperature range:  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

## APPLICATIONS

- Low power RS-485/RS-422 networks
- Isolated interfaces
- Building control networks
- Multipoint data transmission systems

## GENERAL DESCRIPTION

The [ADM2483](#) differential bus transceiver is an integrated, galvanically isolated component designed for bidirectional data communication on balanced, multipoint bus transmission lines. It complies with ANSI EIA/TIA-485-A and ISO 8482: 1987(E). Using Analog Devices' *iCoupler* technology, the [ADM2483](#) combines a 3-channel isolator, a three-state differential line driver, and a differential input receiver into a single package. The logic side of the device is powered with either a 5 V or 3 V supply, and the bus side uses a 5 V supply only.

The [ADM2483](#) is slew-limited to reduce reflections with improperly terminated transmission lines. The controlled slew rate limits the data rate to 500 kbps. The device's input impedance is 96 k $\Omega$ , allowing up to 256 transceivers on the bus. Its driver has an active-high enable feature. The driver differential outputs

## FUNCTIONAL BLOCK DIAGRAM

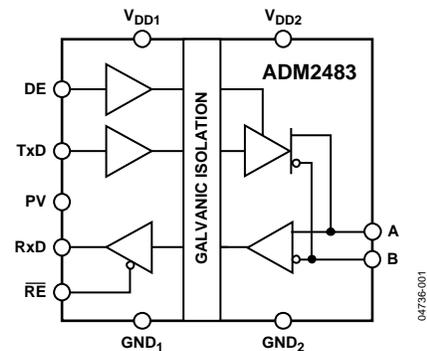


Figure 1.

and receiver differential inputs are connected internally to form a differential I/O port. When the driver is disabled or when  $V_{DD1}$  or  $V_{DD2} = 0$  V, this imposes minimal loading on the bus. An active-high receiver disable feature, which causes the receive output to enter a high impedance state, is provided as well.

The receiver inputs have a true fail-safe feature that ensures a logic-high receiver output level when the inputs are open or shorted. This guarantees that the receiver outputs are in a known state before communication begins and at the point when communication ends.

Current limiting and thermal shutdown features protect against output short circuits and bus contention situations that might cause excessive power dissipation. The part is fully specified over the industrial temperature range and is available in a 16-lead, wide body SOIC package.

# ADM2483\* PRODUCT PAGE QUICK LINKS

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## COMPARABLE PARTS

View a parametric search of comparable parts.

## EVALUATION KITS

- ADM2483 Evaluation Board

## DOCUMENTATION

### Application Notes

- AN-0971: Recommendations for Control of Radiated Emissions with isoPower Devices
- AN-1176: Component Footprints and Symbols in the Binary .Bxl File Format
- AN-1179: Junction Temperature Calculation for Analog Devices RS-485/RS-422, CAN, and LVDS/M-LVDS Transceivers
- AN-727: iCoupler® Isolation in RS-485 Applications
- AN-740: iCoupler® Isolation in RS-232 Applications
- AN-793: ESD/Latch-Up Considerations with iCoupler® Isolation Products
- AN-825: Power Supply Considerations in iCoupler® Isolation Products
- AN-960: RS-485/RS-422 Circuit Implementation Guide

### Data Sheet

- ADM2483: Half-Duplex iCoupler® Isolated RS-485 Transceiver Data Sheet

### User Guides

- UG-239: Evaluation Board for the ADM2483 Half-Duplex iCoupler Isolated RS-485 Transceiver

## SOFTWARE AND SYSTEMS REQUIREMENTS

- ADI RS-485/RS-422 Cross Reference Guide
- RS-232 Transceivers Cross Reference Guide

## REFERENCE MATERIALS

### Press

- Analog Devices Achieves Major Milestone by Shipping 1 Billionth Channel of iCoupler Digital Isolation

### Product Selection Guide

- Digital Isolator Product Selection and Resource Guide

### Solutions Bulletins & Brochures

- Emerging Energy Applications Solutions Bulletin, Volume 10, Issue 4
- Test & Instrumentation Solutions Bulletin, Volume 10, Issue 3

### Technical Articles

- Inside iCoupler® Technology:ADuM347x PWM Controller and Transformer Driver with Quad-Channel Isolators Design Summary
- MS-2127: Designing with iCoupler Digital Isolators in Solar PV Inverters
- NAppkin Note: Lowering the Power of the ADuM524x

## DESIGN RESOURCES

- ADM2483 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

## DISCUSSIONS

View all ADM2483 EngineerZone Discussions.

## SAMPLE AND BUY

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## TECHNICAL SUPPORT

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## DOCUMENT FEEDBACK

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## REVISION HISTORY

### 9/2016—Rev. D to Rev. E

Added Table 4; Renumbered Sequentially ..... 5

### 7/2015—Rev. C to Rev. D

Change to Features Section ..... 1  
 Changes to Table 5 and Table 6..... 6  
 Changes to Ordering Guide .....

### 11/2013—Rev. B to Rev. C

Changes to Features Section..... 1  
 Changes to Table 5..... 6  
 Changes to VDE V 0884-10 Insulation Characteristics Section .... 7  
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### 3/2005—Rev. A to Rev. B

Change to Features..... 1  
 Change to Package Characteristics .....6  
 Changes to Pin Function Descriptions.....8  
 Changes to Figure 9 and Figure 11..... 10  
 Change to Power\_Valid Input Section..... 17  
 Changes to Figure 30..... 17  
 Changes to Ordering Guide .....

### 1/2005—Rev. 0 to Rev. A

Changes to ESD Maximum Rating Specification.....5

### 10/2004—Revision 0: Initial Version

## SPECIFICATIONS

$2.7 \leq V_{DD1} \leq 5.5 \text{ V}$ ,  $4.75 \text{ V} \leq V_{DD2} \leq 5.25 \text{ V}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 1.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
<b>DRIVER</b>					
Differential Outputs					
Differential Output Voltage, $V_{OD}$			5	V	$R = \infty$ , see Figure 3
	2.0		5	V	$R = 50 \Omega$ (RS-422), see Figure 3
	1.5		5	V	$R = 27 \Omega$ (RS-485), see Figure 3
	1.5		5	V	$V_{TST} = -7 \text{ V}$ to $+12 \text{ V}$ , $V_{DD1} \geq 4.75$ , see Figure 4
$\Delta  V_{OD} $ for Complementary Output States			0.2	V	$R = 27 \Omega$ or $50 \Omega$ , see Figure 3
Common-Mode Output Voltage, $V_{OC}$			3	V	$R = 27 \Omega$ or $50 \Omega$ , see Figure 3
$\Delta  V_{OC} $ for Complementary Output States			0.2	V	$R = 27 \Omega$ or $50 \Omega$ , see Figure 3
Output Short-Circuit Current, $V_{OUT} = \text{High}$	-250		+250	mA	$-7 \text{ V} \leq V_{OUT} \leq +12 \text{ V}$
Output Short-Circuit Current, $V_{OUT} = \text{Low}$	-250		+250	mA	$-7 \text{ V} \leq V_{OUT} \leq +12 \text{ V}$
Logic Inputs					
Input High Voltage	$0.7 V_{DD1}$			V	TxD, DE, $\overline{RE}$ , PV
Input Low Voltage			$0.25 V_{DD1}$	V	TxD, DE, $\overline{RE}$ , PV
CMOS Logic Input Current (TxD, DE, $\overline{RE}$ , PV)	-10	+0.01	+10	$\mu\text{A}$	TxD, DE, $\overline{RE}$ , PV = $V_{DD1}$ or 0 V
<b>RECEIVER</b>					
Differential Inputs					
Differential Input Threshold Voltage, $V_{TH}$	-200	-125	-30	mV	$-7 \text{ V} \leq V_{CM} \leq +12 \text{ V}$
Input Hysteresis		20		mV	$-7 \text{ V} \leq V_{CM} \leq +12 \text{ V}$
Input Resistance (A, B)	96	150		k $\Omega$	$-7 \text{ V} \leq V_{CM} \leq +12 \text{ V}$
Input Current (A, B)			0.125	mA	$V_{IN} = +12 \text{ V}$
			-0.1	mA	$V_{IN} = -7 \text{ V}$
Rx/D Logic Output					
Output High Voltage	$V_{DD1} - 0.1$			V	$I_{OUT} = 20 \mu\text{A}$ , $V_A - V_B = 0.2 \text{ V}$
	$V_{DD1} - 0.4$	$V_{DD1} - 0.2$		V	$I_{OUT} = 4 \text{ mA}$ , $V_A - V_B = 0.2 \text{ V}$
Output Low Voltage			0.1	V	$I_{OUT} = -20 \mu\text{A}$ , $V_A - V_B = -0.2 \text{ V}$
			0.4	V	$I_{OUT} = -4 \text{ mA}$ , $V_A - V_B = -0.2 \text{ V}$
Output Short-Circuit Current	7		85	mA	$V_{OUT} = \text{GND}$ or $V_{CC}$
Three-State Output Leakage Current			$\pm 1$	$\mu\text{A}$	$0.4 \text{ V} \leq V_{OUT} \leq 2.4 \text{ V}$
<b>POWER SUPPLY CURRENT</b>					
Logic Side					
			2.5	mA	$4.5 \text{ V} \leq V_{DD1} \leq 5.5 \text{ V}$ , outputs unloaded, $\overline{RE} = 0 \text{ V}$
			1.3	mA	$2.7 \text{ V} \leq V_{DD1} \leq 3.3 \text{ V}$ , outputs unloaded, $\overline{RE} = 0 \text{ V}$
Bus Side					
			2.0	mA	Outputs unloaded, DE = 5 V
			1.7	mA	Outputs unloaded, DE = 0 V
<b>COMMON-MODE TRANSIENT IMMUNITY<sup>1</sup></b>					
	25			kV/ $\mu\text{s}$	TxD = $V_{DD1}$ or 0 V, $V_{CM} = 1 \text{ kV}$ , transient magnitude = 800 V

<sup>1</sup> Common-mode transient immunity is the maximum common-mode voltage slew rate that can be sustained while maintaining specification-compliant operation.  $V_{CM}$  is the common-mode potential difference between the logic and bus sides. The transient magnitude is the range over which the common mode is slewed. The common-mode voltage slew rates apply to both rising and falling common-mode voltage edges.

## TIMING SPECIFICATIONS

$2.7 \leq V_{DD1} \leq 5.5 \text{ V}$ ,  $4.75 \text{ V} \leq V_{DD2} \leq 5.25 \text{ V}$ ,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 2.

Parameter	Min	Typ	Max	Unit	Test Conditions/Comments
<b>DRIVER</b>					
Maximum Data Rate	500			kbps	
Propagation Delay, $t_{PLH}$ , $t_{PHL}$	250		620	ns	$R_{LDIFF} = 54 \Omega$ , $C_{L1} = C_{L2} = 100 \text{ pF}$ , see Figure 5 and Figure 9
Skew, $t_{SKEW}$			40	ns	$R_{LDIFF} = 54 \Omega$ , $C_{L1} = C_{L2} = 100 \text{ pF}$ , see Figure 5 and Figure 9
Rise/Fall Time, $t_R$ , $t_F$	200		600	ns	$R_{LDIFF} = 54 \Omega$ , $C_{L1} = C_{L2} = 100 \text{ pF}$ , see Figure 5 and Figure 9
Enable Time			1050	ns	$R_L = 500 \Omega$ , $C_L = 100 \text{ pF}$ , see Figure 6 and Figure 11
Disable Time			1050	ns	$R_L = 500 \Omega$ , $C_L = 15 \text{ pF}$ , see Figure 6 and Figure 11
<b>RECEIVER</b>					
Propagation Delay, $t_{PLH}$ , $t_{PHL}$	400		1050	ns	$C_L = 15 \text{ pF}$ , see Figure 7 and Figure 10
Differential Skew, $t_{SKEW}$			250	ns	$C_L = 15 \text{ pF}$ , see Figure 7 and Figure 10
Enable Time		25	70	ns	$R_L = 1 \text{ k}\Omega$ , $C_L = 15 \text{ pF}$ , see Figure 8 and Figure 12
Disable Time		40	70	ns	$R_L = 1 \text{ k}\Omega$ , $C_L = 15 \text{ pF}$ , see Figure 8 and Figure 12
<b>POWER VALID INPUT</b>					
Enable Time		1	2	$\mu\text{s}$	
Disable Time		3	5	$\mu\text{s}$	

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted. All voltages are relative to their respective ground.

Table 3.

Parameter	Rating
$V_{DD1}$	-0.5 V to +7 V
$V_{DD2}$	-0.5 V to +6 V
Digital Input Voltage (DE, $\overline{\text{RE}}$ , TxD)	-0.5 V to $V_{DD1} + 0.5$ V
Digital Output Voltage RxD	-0.5 V to $V_{DD1} + 0.5$ V
Driver Output/Receiver Input Voltage	-9 V to +14 V
ESD Rating: Contact (Human Body Model) (A, B Pins)	$\pm 2$ kV
Operating Temperature Range	-40°C to +85°C
Storage Temperature Range	-55°C to +150°C
Average Output Current per Pin	-35 mA to +35 mA
$\theta_{JA}$ Thermal Impedance	73°C/W
Lead Temperature	
Soldering (10 sec)	260°C
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

Table 4. Maximum Continuous Working Voltage<sup>1</sup>

Parameter	Max	Unit	Reference Standard
AC Voltage			
Bipolar Waveform			
Basic Insulation	565	$V_{PEAK}$	50-year minimum lifetime
Reinforced Insulation	565	$V_{PEAK}$	50-year minimum lifetime
Unipolar Waveform			
Basic Insulation	1131	$V_{PEAK}$	50-year minimum lifetime
Reinforced Insulation	864	$V_{PEAK}$	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
DC Voltage			
Basic Insulation	1066	$V_{PEAK}$	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1
Reinforced Insulation	529	$V_{PEAK}$	Lifetime limited by package creepage maximum approved working voltage per IEC 60950-1

<sup>1</sup> Refers to continuous voltage magnitude imposed across the isolation barrier.

### ESD CAUTION



#### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PACKAGE CHARACTERISTICS

Table 5.

Parameter	Symbol	Min	Typ	Max	Unit	Test Conditions
Resistance (Input-Output) <sup>1</sup>	$R_{I-O}$		10 <sup>12</sup>		$\Omega$	
Capacitance (Input-Output) <sup>1</sup>	$C_{I-O}$		3		pF	f = 1 MHz
Input Capacitance <sup>2</sup>	$C_i$		4		pF	
Input IC Junction-to-Case Thermal Resistance	$\theta_{JCI}$		33		$^{\circ}\text{C}/\text{W}$	Thermocouple located at center of package underside
Output IC Junction-to-Case Thermal Resistance	$\theta_{JCO}$		28		$^{\circ}\text{C}/\text{W}$	Thermocouple located at center of package underside

<sup>1</sup> Device considered a 2-terminal device: Pins 1, 2, 3, 4, 5, 6, 7, and 8 shorted together, and Pins 9, 10, 11, 12, 13, 14, 15, and 16 shorted together.

<sup>2</sup> Input capacitance is from any input data pin to ground.

## REGULATORY INFORMATION

The ADM2483 has been approved by the following organizations:

Table 6.

UL <sup>1</sup>	CSA	CQC	VDE <sup>2</sup>
Recognized Under 1577 Component Recognition Program	Approved under CSA Component Acceptance Notice 5A IEC 609501 800 V rms (1131 V <sub>PEAK</sub> ) basic, 400 V rms (565 V <sub>PEAK</sub> ) reinforced	Approved Under CQC11-471543-2012  Basic insulation per GB4943.1-2011, 415 V rms (588 V <sub>PEAK</sub> ) maximum working voltage, tropical climate, altitude ≤ 5000 meters	Certified according to DIN V VDE V 0884-10 (VDE V 0884-10): 2006-12
File E214100	File 205078	File CQC14001114898	File 2471900-4880-0001

<sup>1</sup> In accordance with UL1577, each ADM2483 is proof tested by applying an insulation test voltage ≥3000 V rms for 1 sec (current leakage detection limit = 5  $\mu\text{A}$ ).

<sup>2</sup> In accordance with VDE V 0884-10, each ADM2483 is proof tested by applying an insulation test voltage ≥1050 V<sub>PEAK</sub> for 1 sec (partial discharge detection limit = 5 pC).

## INSULATION AND SAFETY-RELATED SPECIFICATIONS

Table 7.

Parameter	Symbol	Value	Unit	Conditions
Rated Dielectric Insulation Voltage		2500	V rms	1-minute duration
Minimum External Air Gap (Clearance)	L(I01)	7.45 min	mm	Measured from input terminals to output terminals, shortest distance through air
Minimum External Tracking (Creepage)	L(I02)	8.1 min	mm	Measured from input terminals to output terminals, shortest distance along body
Minimum Internal Gap (Internal Clearance)		0.017 min	mm	Insulation distance through insulation
Tracking Resistance (Comparative Tracking Index)	CTI	>400	V	DIN IEC 112/VDE 0303 Part 1
Isolation Group		II		Material Group (Table 1 in DIN VDE 0110,1/89)

**VDE V 0884-10 INSULATION CHARACTERISTICS**

This isolator is suitable for reinforced electrical isolation only within this safety limit data. Maintenance of this safety data shall be ensured by means of protective circuits.

An asterisk (\*) on the physical package denotes VDE V 0884-10 approval for 560 V peak working voltage.

**Table 8.**

<b>Description</b>	<b>Symbol</b>	<b>Characteristic</b>	<b>Unit</b>
Installation Classification per DIN VDE 0110 for Rated Mains Voltage		I to IV	
≤150 V rms		I to III	
≤300 V rms		I to II	
≤400 V rms		40/100/21	
Climatic Classification		2	
Pollution Degree (Table 1 in DIN VDE 0110)		560	V <sub>PEAK</sub>
Maximum Working Insulation Voltage	V <sub>IORM</sub>	1050	V <sub>PEAK</sub>
Input to Output test Voltage, Method b1	V <sub>PR</sub>		
V <sub>IORM</sub> × 1.875 = V <sub>PR</sub> , 100% Production Tested			
t <sub>m</sub> = 1 sec, Partial Discharge <5 pC			
Input-to-Output Test Voltage, Method a			
(After Environmental Tests, Subgroup 1)		896	V <sub>PEAK</sub>
V <sub>IORM</sub> × 1.6 = V <sub>PR</sub> , t <sub>m</sub> = 60 sec, Partial Discharge <5 pC			
(After Input and/or Safety Test, Subgroup 2/3)			
V <sub>IORM</sub> × 1.2 = V <sub>PR</sub> , t <sub>m</sub> = 60 sec, Partial Discharge <5 pC	V <sub>PR</sub>	672	V <sub>PEAK</sub>
Highest Allowable Overvoltage			
(Transient Overvoltage, t <sub>TR</sub> = 10 sec)	V <sub>TR</sub>	4000	V <sub>PEAK</sub>
Safety-Limiting Values (Maximum Value Allowed in the Event of a Failure. See Figure 23.)			
Case Temperature	T <sub>S</sub>	150	°C
Input Current	I <sub>S, INPUT</sub>	265	mA
Output Current	I <sub>S, OUTPUT</sub>	335	mA
Insulation Resistance at T <sub>S</sub> , V <sub>IO</sub> = 500 V	R <sub>S</sub>	>10 <sup>9</sup>	Ω

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

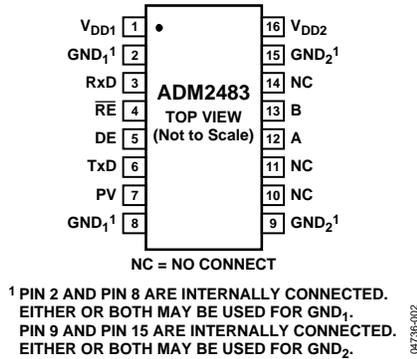


Figure 2. Pin Configuration

Table 9. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	V <sub>DD1</sub>	Power Supply (Logic Side).
2, 8	GND <sub>1</sub>	Ground (Logic Side).
3	RxD	Receiver Output Data. When enabled, if $(A - B) \geq -30$ mV, then RxD = high. If $(A - B) \leq -200$ mV, then RxD = low. This is a tristate output when the receiver is disabled, that is, when $\overline{RE}$ is driven high.
4	$\overline{RE}$	Receiver Enable Input. This is an active-low input. Driving this input low enables the receiver, and driving it high disables the receiver.
5	DE	Driver Enable Input. Driving the input high enables the driver, and driving it low disables the driver.
6	TxD	Transmit Data Input. Data to be transmitted by the driver is applied to this input.
7	PV	Power_Valid. Used during power-up and power-down. See the Applications Information section.
9, 15	GND <sub>2</sub>	Ground (Bus Side).
10, 11, 14	NC	No Connect.
12	A	Noninverting Driver Output/Receiver Input. When the driver is disabled, or when V <sub>DD1</sub> or V <sub>DD2</sub> is powered down, Pin A is put into a high impedance state to avoid overloading the bus.
13	B	Inverting Driver Output/Receiver Input. When the driver is disabled, or when V <sub>DD1</sub> or V <sub>DD2</sub> is powered down, Pin B is put into a high impedance state to avoid overloading the bus.
16	V <sub>DD2</sub>	Power Supply (Bus Side).

TEST CIRCUITS

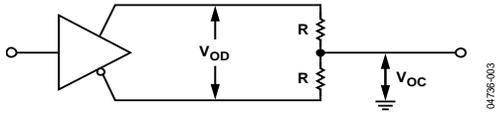


Figure 3. Driver Voltage Measurement

04736-003

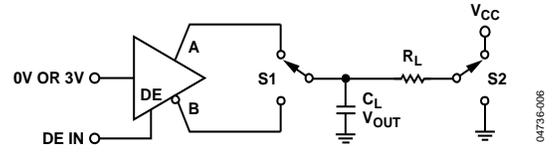


Figure 6. Driver Enable/Disable

04736-006

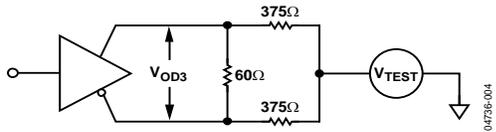


Figure 4. Driver Voltage Measurement

04736-004

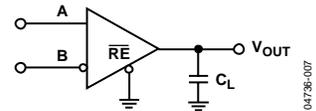


Figure 7. Receiver Propagation Delay

04736-007

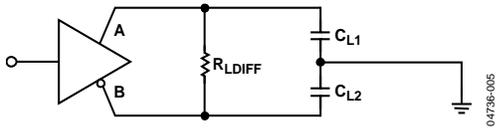


Figure 5. Driver Propagation Delay

04736-005

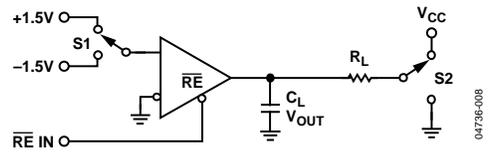


Figure 8. Receiver Enable/Disable

04736-008

### SWITCHING CHARACTERISTICS

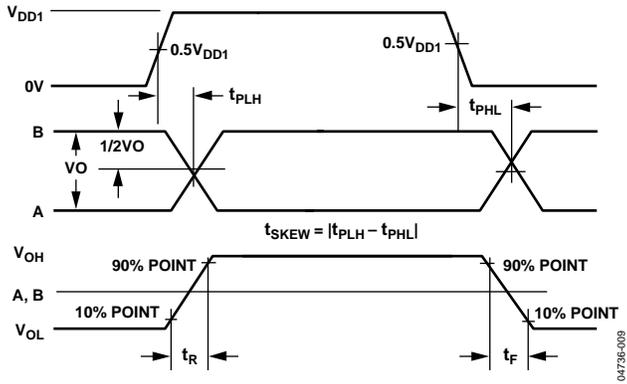


Figure 9. Driver Propagation Delay, Rise/Fall Timing

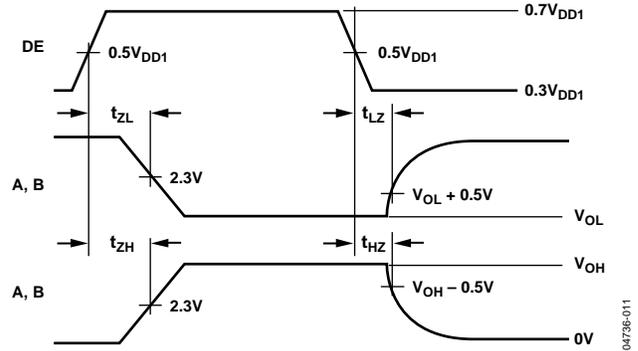


Figure 11. Driver Enable/Disable Timing

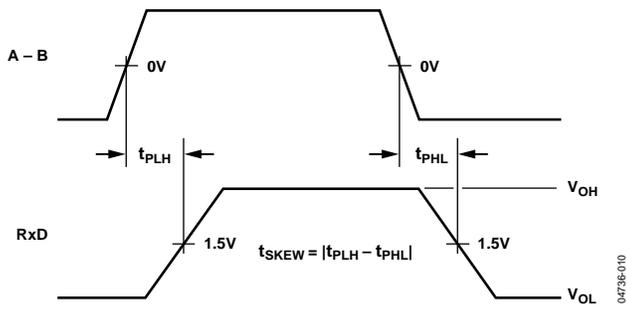


Figure 10. Receiver Propagation Delay

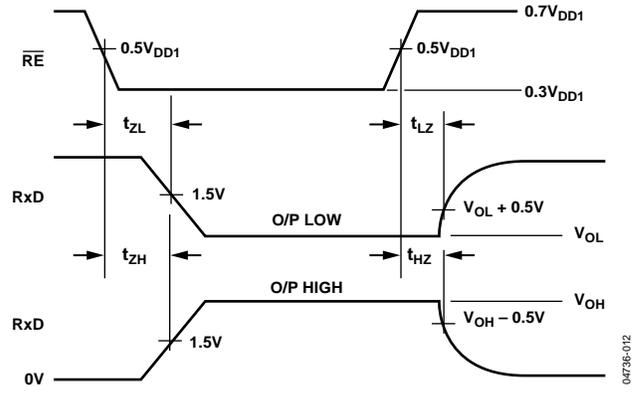


Figure 12. Receiver Enable/Disable Timing

### TYPICAL PERFORMANCE CHARACTERISTICS

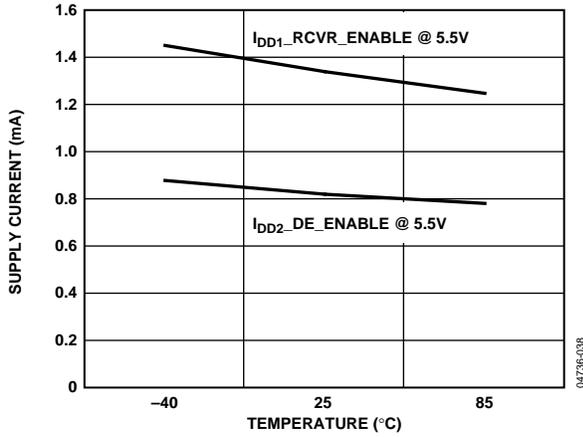


Figure 13. Unloaded Supply Current vs. Temperature

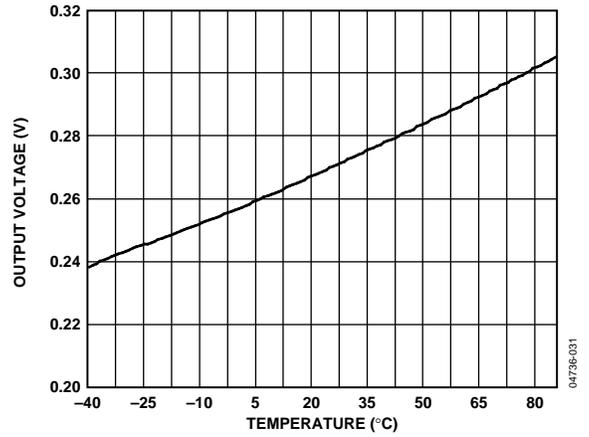


Figure 16. Receiver Output Low Voltage vs. Temperature,  $I = -4\text{mA}$

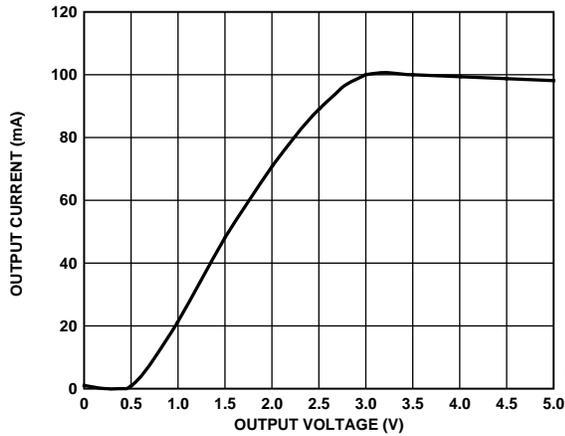


Figure 14. Output Current vs. Driver Output Low Voltage

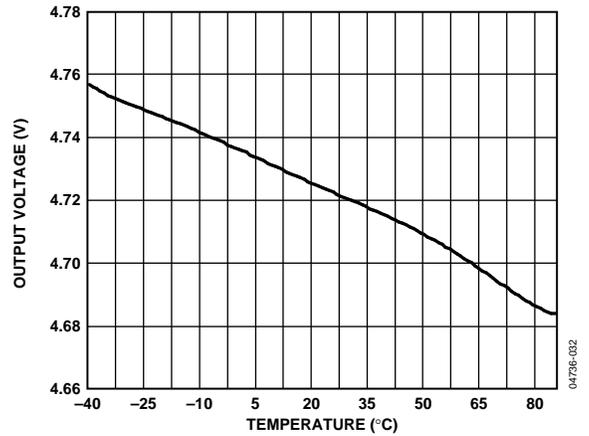


Figure 17. Receiver Output High Voltage vs. Temperature,  $I = 4\text{ mA}$

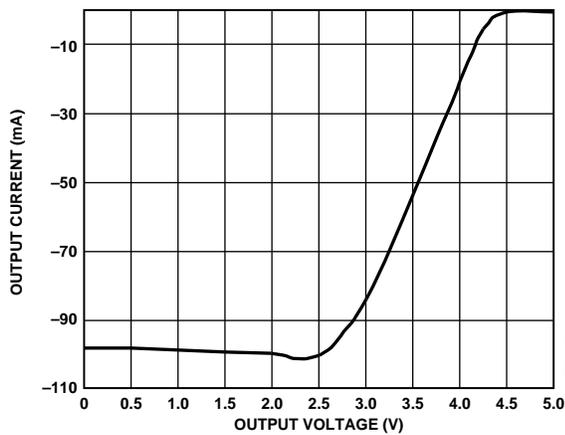


Figure 15. Output Current vs. Driver Output High Voltage

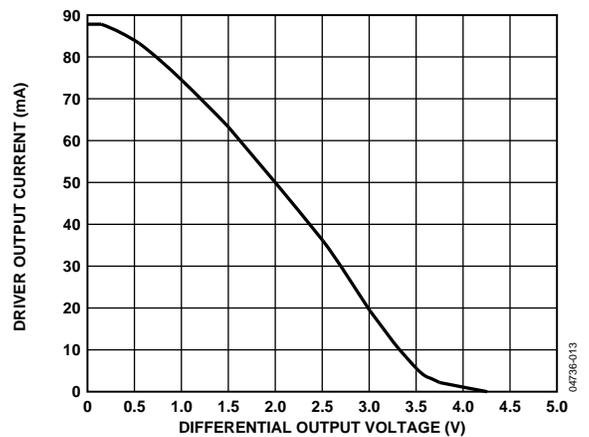


Figure 18. Driver Output Current vs. Differential Output Voltage

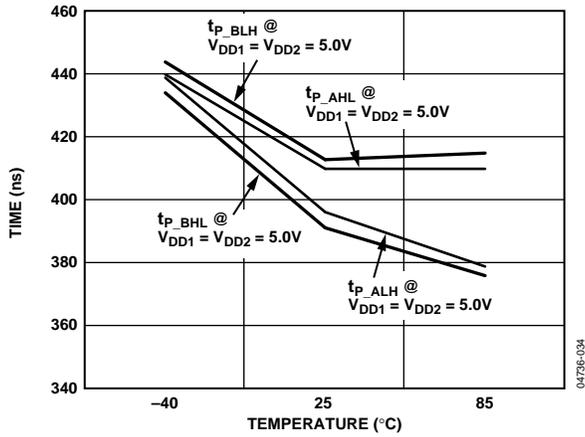


Figure 19. Driver Propagation Delay vs. Temperature

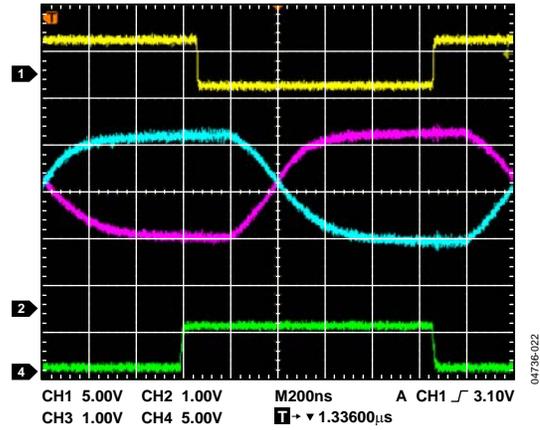


Figure 21. Driver/Receiver Propagation Delay High to Low

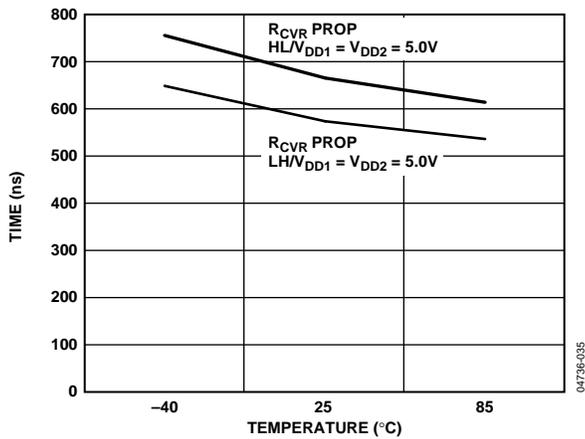


Figure 20. Receiver Propagation Delay vs. Temperature

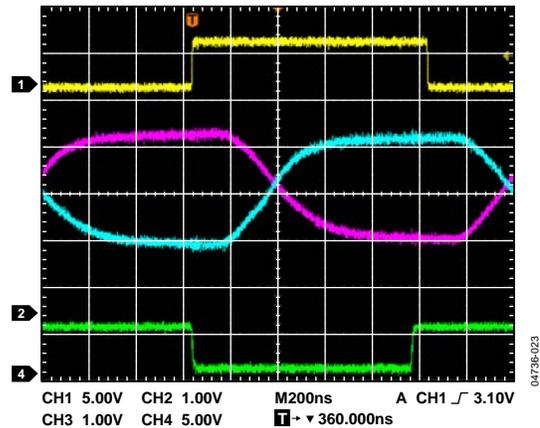


Figure 22. Driver/Receiver Propagation Delay Low to High

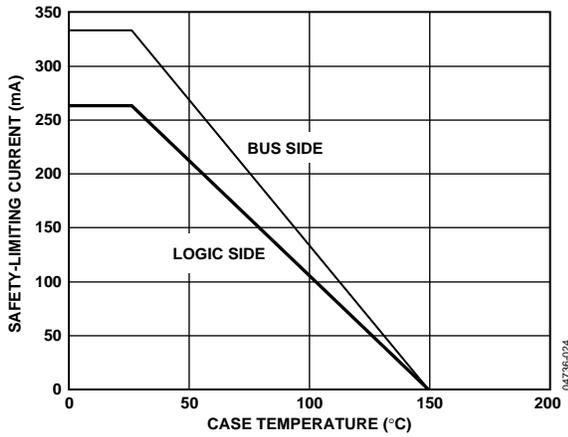


Figure 23. Thermal Derating Curve, Dependence of Safety-Limiting Values with Case Temperature per VDE V 0884

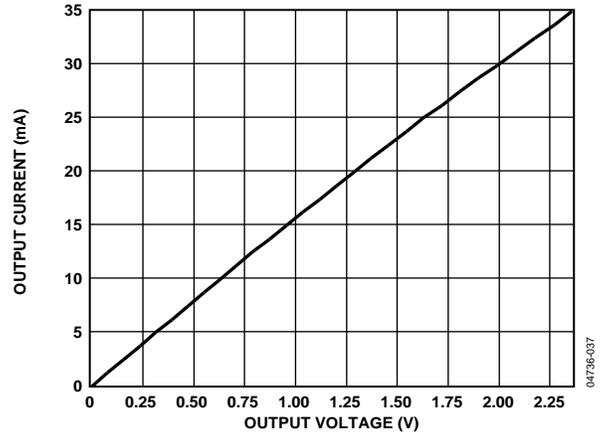


Figure 25. Output Current vs. Receiver Output Low Voltage

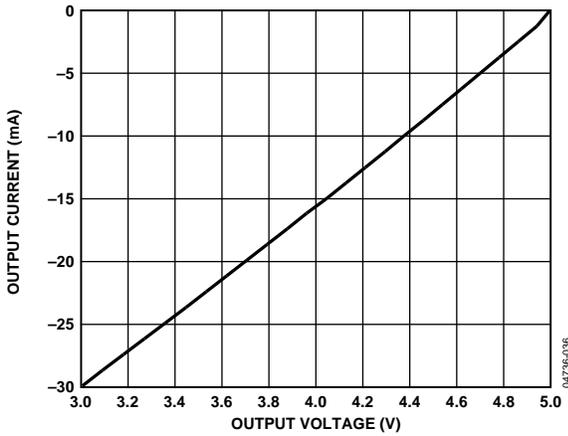


Figure 24. Output Current vs. Receiver Output High Voltage

# CIRCUIT DESCRIPTION

## ELECTRICAL ISOLATION

In the [ADM2483](#), electrical isolation is implemented on the logic side of the interface. Therefore, the part has two main sections: a digital isolation section and a transceiver section (see Figure 26). Driver input and data enable signals, applied to the TxD and DE pins, respectively, and referenced to logic ground ( $GND_1$ ), are coupled across an isolation barrier to appear at the transceiver section referenced to isolated ground ( $GND_2$ ).

Similarly, the receiver output, referenced to isolated ground in the transceiver section, is coupled across the isolation barrier to appear at the RxD pin referenced to logic ground.

## *iCoupler Technology*

The digital signals are transmitted across the isolation barrier using *iCoupler* technology. This technique uses chip-scale transformer windings to couple the digital signals magnetically from one side of the barrier to the other. Digital inputs are encoded into waveforms that are capable of exciting the primary transformer winding. At the secondary winding, the induced waveforms are then decoded into the binary value that was originally transmitted.

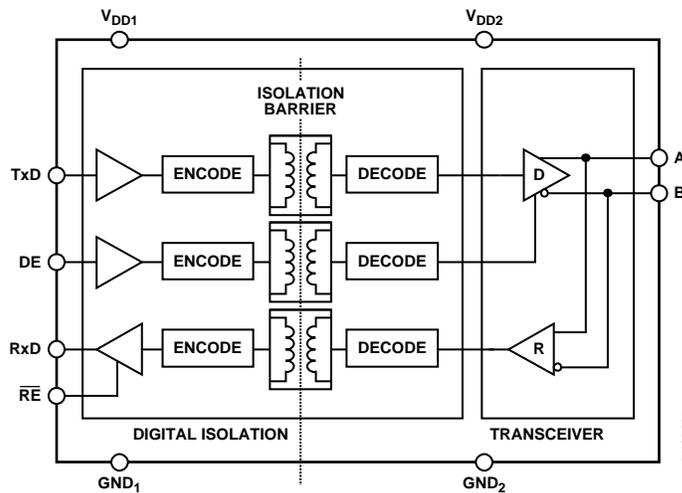


Figure 26. ADM2483 Digital Isolation and Transceiver Sections

**TRUTH TABLES**

The following truth tables use these abbreviations:

Letter	Description
H	High level
L	Low level
X	Irrelevant
Z	High impedance (off)
NC	Disconnected

**Table 10. Transmitting**

Supply Status		Inputs		Outputs	
V <sub>DD1</sub>	V <sub>DD2</sub>	DE	TxD	A	B
On	On	H	H	H	L
On	On	H	L	L	H
On	On	L	X	Z	Z
On	Off	X	X	Z	Z
Off	On	X	X	Z	Z
Off	Off	X	X	Z	Z

**Table 11. Receiving**

Supply Status		Inputs		Outputs
V <sub>DD1</sub>	V <sub>DD2</sub>	A – B (V)	$\overline{\text{RE}}$	RxD
On	On	>–0.03	L or NC	H
On	On	<–0.2	L or NC	L
On	On	–0.2 < A – B < –0.03	L or NC	Indeterminate
On	On	Inputs open	L or NC	H
On	On	X	H	Z
On	Off	X	L or NC	H
Off	On	X	L or NC	H
Off	Off	X	L or NC	L

**POWER-UP/POWER-DOWN CHARACTERISTICS**

The power-up/power-down characteristics of the ADM2483 are in accordance with the supply thresholds shown in Table 12. Upon power-up, the ADM2483 output signals (A, B, and RxD) reach their correct state once both supplies exceed their thresholds. Upon power-down, the ADM2483 output signals retain their correct state until at least one of the supplies drops below its power-down threshold. When the V<sub>DD1</sub> power-down threshold is crossed, the ADM2483 output signals reach their unpowered states within 4 μs.

**Table 12. Power-Up/Power-Down Thresholds**

Supply	Transition	Threshold (V)
V <sub>DD1</sub>	Power-up	2.0
V <sub>DD1</sub>	Power-down	1.0
V <sub>DD2</sub>	Power-up	3.3
V <sub>DD2</sub>	Power-down	2.4

**THERMAL SHUTDOWN**

The ADM2483 contains thermal shutdown circuitry that protects the part from excessive power dissipation during fault conditions. Shorting the driver outputs to a low impedance source can result in high driver currents. The thermal sensing circuitry detects the increase in die temperature under this condition and disables the driver outputs. This circuitry is designed to disable the driver outputs when a die temperature of 150°C is reached. As the device cools, the drivers are re-enabled at a temperature of 140°C.

**TRUE FAIL-SAFE RECEIVER INPUTS**

The receiver inputs have a true fail-safe feature, which ensures that the receiver output is high when the inputs are open or shorted. During line-idle conditions, when no driver on the bus is enabled, the voltage across a terminating resistance at the receiver input decays to 0 V. With traditional transceivers, receiver input thresholds specified between –200 mV and +200 mV mean that external bias resistors are required on the A and B pins to ensure that the receiver outputs are in a known state. The true fail-safe receiver input feature eliminates the need for bias resistors by specifying the receiver input threshold between –30 mV and –200 mV. The guaranteed negative threshold means that when the voltage between A and B decays to 0 V, the receiver output is guaranteed to be high.

**MAGNETIC FIELD IMMUNITY**

Because iCouplers use a coreless technology, no magnetic components are present, and the problem of magnetic saturation of the core material does not exist. Therefore, iCouplers have essentially infinite dc field immunity. The analysis that follows defines the conditions under which this might occur. The ADM2483's 3 V operating condition is examined because it represents the most susceptible mode of operation.

The limitation on the iCoupler's ac magnetic field immunity is set by the condition in which the induced error voltage in the receiving coil (the bottom coil in this case) is made sufficiently large, either to falsely set or reset the decoder. The voltage induced across the bottom coil is given by

$$V = \left( \frac{-d\beta}{dt} \right) \sum \pi r_n^2; \quad n = 1, 2, \dots, N$$

where if the pulses at the transformer output are greater than 1.0 V in amplitude:

$\beta$  = magnetic flux density (gauss)

$N$  = number of turns in receiving coil

$r_n$  = radius of nth turn in receiving coil (cm)

The decoder has a sensing threshold of about 0.5 V; therefore, there is a 0.5 V margin in which induced voltages can be tolerated.

Given the geometry of the receiving coil and an imposed

requirement that the induced voltage is, at most, 50% of the 0.5 V margin at the decoder, a maximum allowable magnetic field is calculated, as shown in Figure 27.

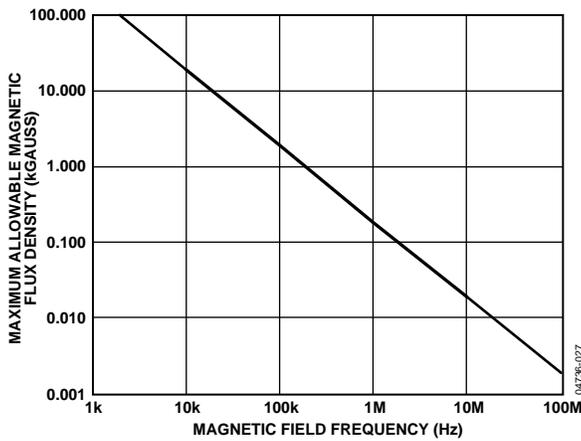


Figure 27. Maximum Allowable External Magnetic Flux Density

For example, at a magnetic field frequency of 1 MHz, the maximum allowable magnetic field of 0.2 kGauss induces a voltage of 0.25 V at the receiving coil. This is about 50% of the sensing threshold and does not cause a faulty output transition. Similarly, if such an event occurs during a transmitted pulse and is the worst-case polarity, it reduces the received pulse from >1.0 V to 0.75 V. This is well above the 0.5 V sensing threshold of the decoder.

These magnetic flux density values are shown in Figure 28, using more familiar quantities such as maximum allowable current flow, at given distances away from the ADM2483 transformers.

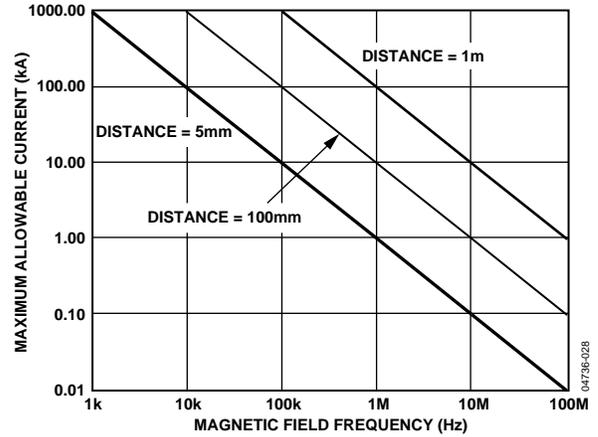


Figure 28. Maximum Allowable Current for Various Current-to-ADM2483 Spacings

At combinations of strong magnetic field and high frequency, any loops formed by printed circuit board traces could induce large enough error voltages to trigger the thresholds of succeeding circuitry. To avoid this possibility, care should be taken in the layout of such traces.

## APPLICATIONS INFORMATION

### POWER\_VALID INPUT

To avoid chatter on the A and B outputs caused by slow power-up and power-down transients on  $V_{DD1}$  ( $>100 \mu\text{s/V}$ ), the ADM2483 features a power\_valid (PV) digital input. This pin should be driven low until  $V_{DD1}$  exceeds 2.0 V. When  $V_{DD1}$  is greater than 2.0 V, the pin should be driven high. Conversely, upon power-down, the PV should be driven low before  $V_{DD1}$  reaches 2.0 V.

The power\_valid input can be driven, for example, by the output of a system reset circuit such as the ADM809Z, which has a threshold voltage of 2.32 V.

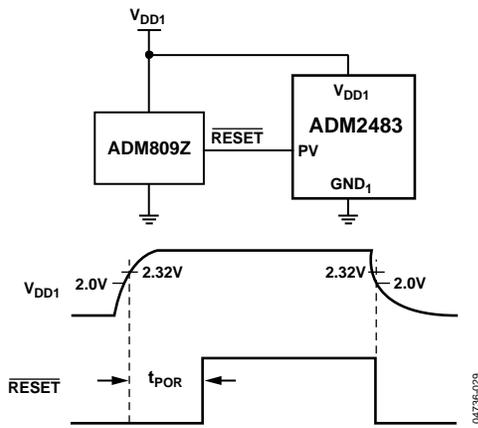


Figure 29. Driving PV with ADM809Z

### ISOLATED POWER SUPPLY CIRCUIT

The ADM2483 requires isolated power capable of 5 V at 100 mA to be supplied between the  $V_{DD2}$  and  $GND_2$  pins. If no suitable integrated power supply is available, a discrete circuit, such as the one in Figure 30, can be used. A center-tapped transformer provides electrical isolation. The primary winding is excited with a pair of square waveforms that are 180° out of phase with each other. A pair of Schottky diodes and a smoothing capacitor are used to create a rectified signal from the secondary winding. The ADP667 linear voltage regulator provides a regulated power supply to the ADM2483's bus-side circuitry.

To create the pair of square waves, a D-type flip-flop with complementary  $Q/\bar{Q}$  outputs is used. The flip-flop can be connected so that output Q follows the clock input signal. If no local clock signal is available, a simple digital oscillator can be implemented with a hex-inverting Schmitt trigger and a resistor and capacitor. In this case, values of 3.9 kΩ and 1 nF generate a 364 kHz square wave. A pair of discrete NMOS transistors, switched by the  $Q/\bar{Q}$  flip-flop outputs, conduct current through the center tap of the primary transformer, winding in an alternating fashion.

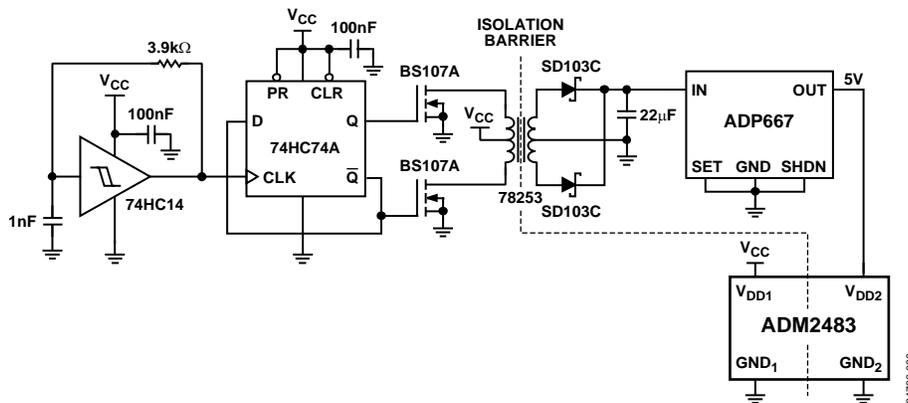
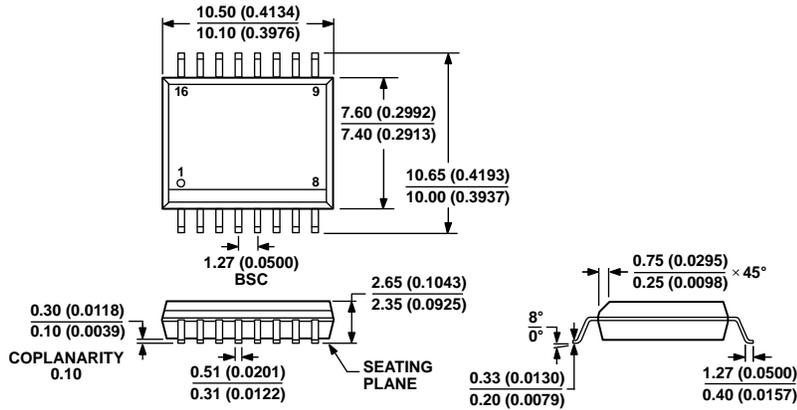


Figure 30. Isolated Power Supply Circuit

OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-013-AA  
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS  
 (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR  
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 31. 16-Lead Standard Small Outline Package [SOIC\_W]  
 Wide Body  
 (RW-16)

Dimensions shown in millimeters and (inches)

03-27-2007-49

ORDERING GUIDE

Model <sup>1,2</sup>	Data Rate (kbps)	Temperature Range	Package Description	Package Option
ADM2483BRW	500	-40°C to +85°C	16-Lead, Wide Body SOIC_W	RW-16
ADM2483BRW-REEL	500	-40°C to +85°C	16-Lead, Wide Body SOIC_W	RW-16
ADM2483BRWZ	500	-40°C to +85°C	16-Lead, Wide Body SOIC_W	RW-16
ADM2483BRWZ-REEL	500	-40°C to +85°C	16-Lead, Wide Body SOIC_W	RW-16
EVAL-ADM2483EBZ			ADM2483 Evaluation Board	

<sup>1</sup> Z = RoHS Compliant Part.

<sup>2</sup> -REEL suffix designates a 13-inch (1,000 units) tape-and-reel option.